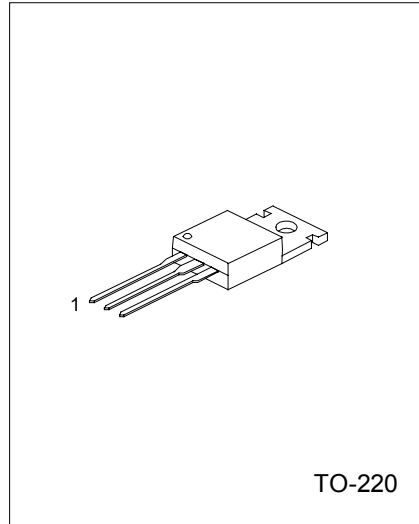


TRIACS

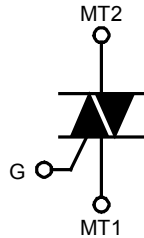
DESCRIPTION

Passivated triacs in a plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.



1:MT1 2:MT2 3:GATE

SYMBOL



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT
Repetitive Peak Off State Voltage UT137F/G-5 UT137F/G-6 UT137F/G-8	V _{DRM}	500* 600* 800	V
RMS On-state Current (Full sine wave, T _{mb} ≤ 102°C)	I _{T(RMS)}	8	A
Non-Repetitive Peak. On-State Current (Full sine wave, T _j = 25°C prior to surge) t = 20ms t = 16.7ms	I _{TSM}	65 71	A
I ² t For Fusing (t = 10ms)	I ² t	21	A ² s
Repetitive Rate of Rise of On-state Current after Triggering I _{TM} = 12A, I _G = 0.2A, dI _G /dt = 0.2A/μs T2+ G+ T2+ G- T2- G- T2- G+	dI _T /dt	50 50 50 10	A/μs
Peak Gate Voltage	V _{GM}	5	V
Peak Gate Current	I _{GM}	2	A
Peak Gate Power	P _{GM}	5	W
Average Gate Power (Over any 20ms period)	P _{G(AV)}	0.5	W
Operating Junction Temperature	T _j	125	°C
Storage Temperature	T _{stg}	-40~150	°C

*Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6A/μs.

THERMAL RESISTANCES

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Thermal Resistance Junction to Mounting Base Full cycle	Rth j-mb			2.0	K/W
Half cycle				2.4	
Thermal Resistance Junction to Ambient In free air	Rth j-a		60		K/W

STATIC CHARACTERISTICS (Tj=25°C, unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX		UNIT
					UT137F	UT137G	
Gate trigger current	IGT	V _D =12V, I _T =0.1A					mA
		T2+ G+		5	25	50	
		T2+ G-		8	25	50	
		T2- G-		11	25	50	
		T2- G+		30	70	100	
Latching current	IL	V _D =12V, I _{GT} =0.1A					mA
		T2+ G+		7	30	45	
		T2+ G-		16	45	60	
		T2- G-		5	30	45	
		T2- G+		7	45	60	
Holding current	I _H	V _D = 12 V, I _{GT} = 0.1 A		5	20	40	mA
On-state voltage	V _T	I _T =10A		1.3	1.65		V
Gate trigger voltage	V _{GT}	V _D =12V, I _T =0.1A		0.7	1.5		V
		V _D =400V, I _T =0.1A, T _J =125°C	0.25	0.4			V
Off-state leakage current	I _D	V _D =V _{DRM(max)} , T _J =125°C		0.1	0.5		mA

DYNAMIC CHARACTERISTICS (Tj=25°C, unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN		TYP	MAX	UNIT
			UT137F	UT137G			
Critical rate of rise of Off-state voltage	dV _D /dt	V _{DM} = 67% V _{DRM(max)} , T _J =125°C, exponential waveform, gate open circuit	50	200	250		V/μs
Critical rate of change of Commutating voltage	dV _{com} /dt	V _{DM} =400V, T _J =95°C, I _{T(RMS)} =8A, dI _{com} /dt =3.6A/ms, gate open circuit		10	20		V/μs
Gate controlled turn-on time	t _{gt}	I _{TM} = 12 A, V _D = V _{DRM(max)} , I _G =0.1A, dI _G /dt=5A/μs			2		μs

TYPICAL CHARACTERISTICS

Figure 1. Maximum on-state Dissipation, P_{tot} vs RMS On-state Current, $I_T(RMS)$, Where α = conduction Angle.

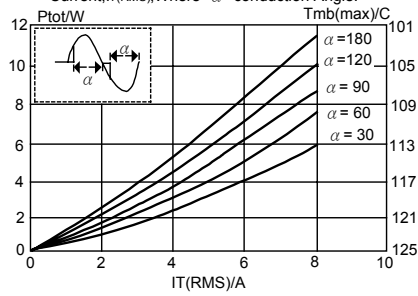


Figure 2. Maximum Permissible Non-repetitive Peak On-state Current I_{TSM} , vs Pulse Width t_p , for Sinusoidal Currents, $t_p \leq 20ms$.

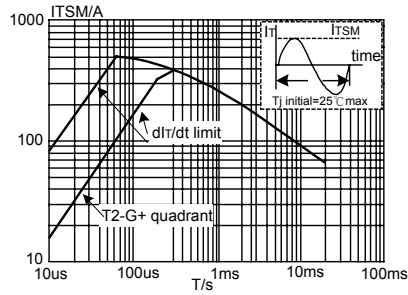


Figure 3. Maximum Permissible Non-Repetitive peak on-state Current I_{TSM} , vs Number of Cycles, for Sinusoidal Current, $f = 50Hz$.

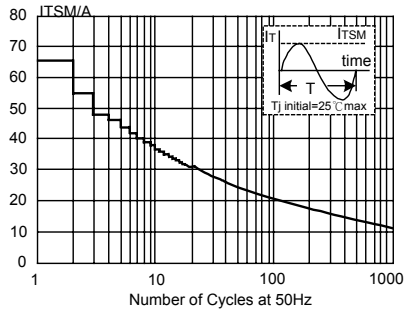


Figure 4. Maximum Permissible RMS Current $I_T(RMS)$ vs mounting base Temperature T_{mb} .

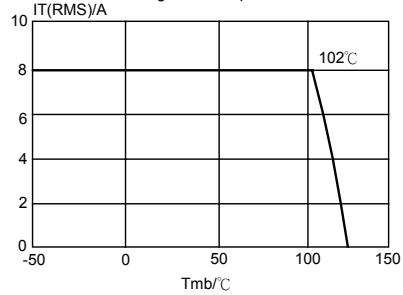


Figure 5. Maximum Permissible Repetitive RMS on-state Current $I_T(RMS)$, vs Surge Duration, for Sinusoidal Currents, $f = 50Hz$, $T_{mb} \leq 102^\circ C$.

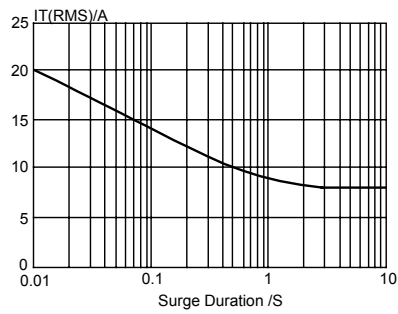


Figure 6. Normalised Gate Trigger Voltage $V_{GT}(T_j) / V_{GT}(25^\circ C)$, vs Junction Temperature T_j .

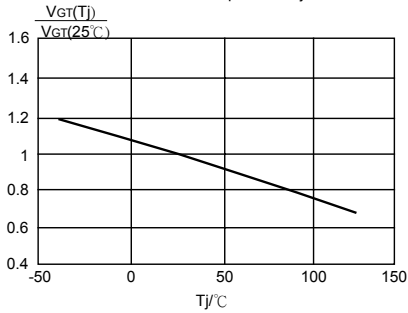


Figure 7. Normalised Gate Trigger Current $I_{GT}(T_j)/I_{GT}(25^\circ\text{C})$, vs Junction Temperature T_j .

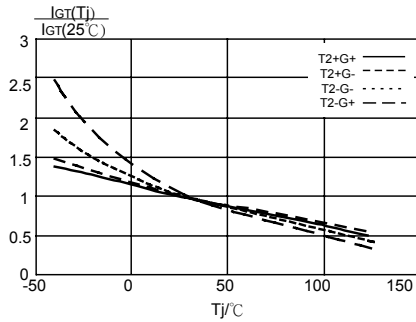


Figure 8. Normalised Latching Current $I_L(T_j)/I_L(25^\circ\text{C})$, vs Junction Temperature T_j .

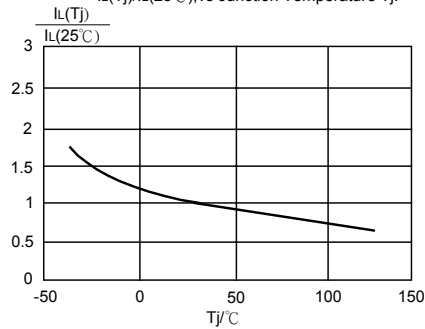


Figure 9. Normalised Holding Current $I_H(T_j)/I_H(25^\circ\text{C})$, vs Junction Temperature T_j .

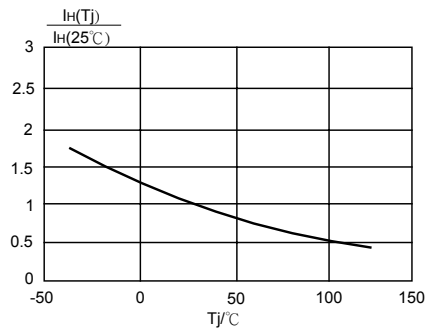


Figure 10. Typical and Maximum On-state Characteristic.

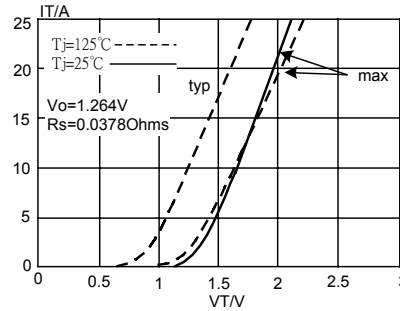


Figure 11. Transient Thermal Impedance $Z_{th\ j-mb}$, vs Pulse Width t_p .

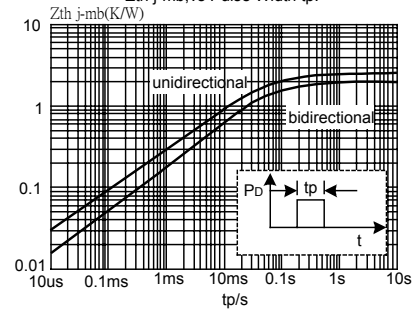
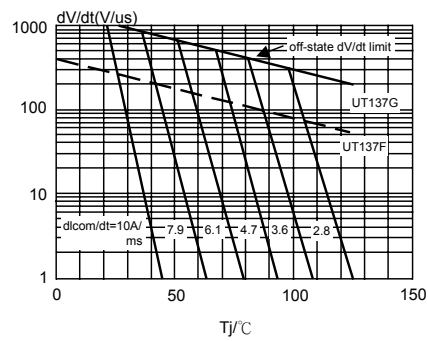


Figure 12. Typical commutation dV/dt vs junction temperature, parameter commutation dI/dt . The triac should commute when the dV/dt is below the value on the appropriate curve for pre-commutation dI/dt .



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